

System test

Slide per discussione

draft

# Half Ring 1



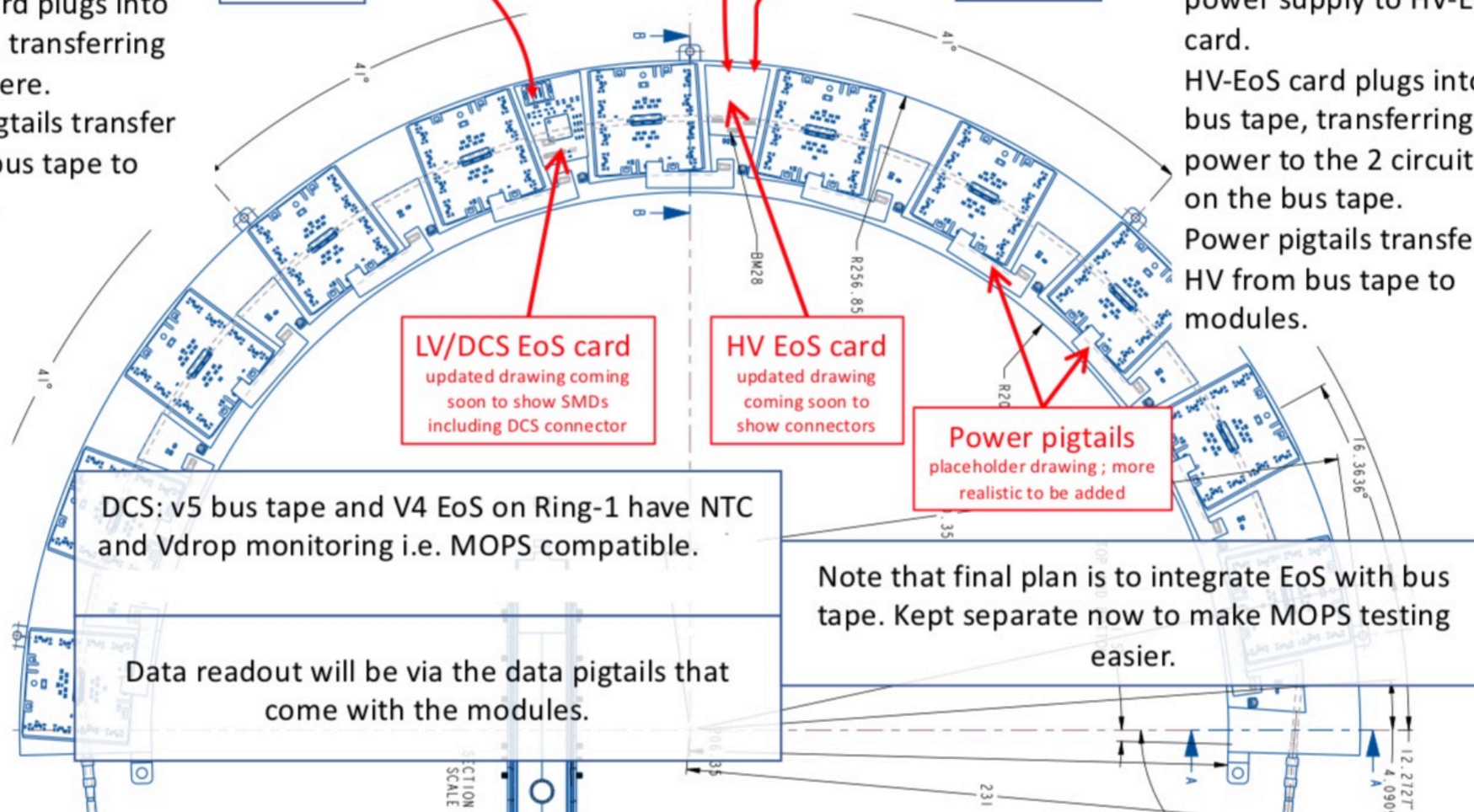
## Ring 1

LV goes through Type I cable from power supply to LV-EoS card. LV-EoS card plugs into bus tape, transferring power there. Power pigtailed transfer LV from bus tape to modules.



HV (2 circuits per SP chain) goes through Type I cables from power supply to HV-EoS card. HV-EoS card plugs into bus tape, transferring power to the 2 circuits on the bus tape. Power pigtailed transfer HV from bus tape to modules.

Layer 3 prototype. 11 modules per SP chain (side)



LV/DCS EoS card updated drawing coming soon to show SMDs including DCS connector

HV EoS card updated drawing coming soon to show connectors

Power pigtailed placeholder drawing; more realistic to be added

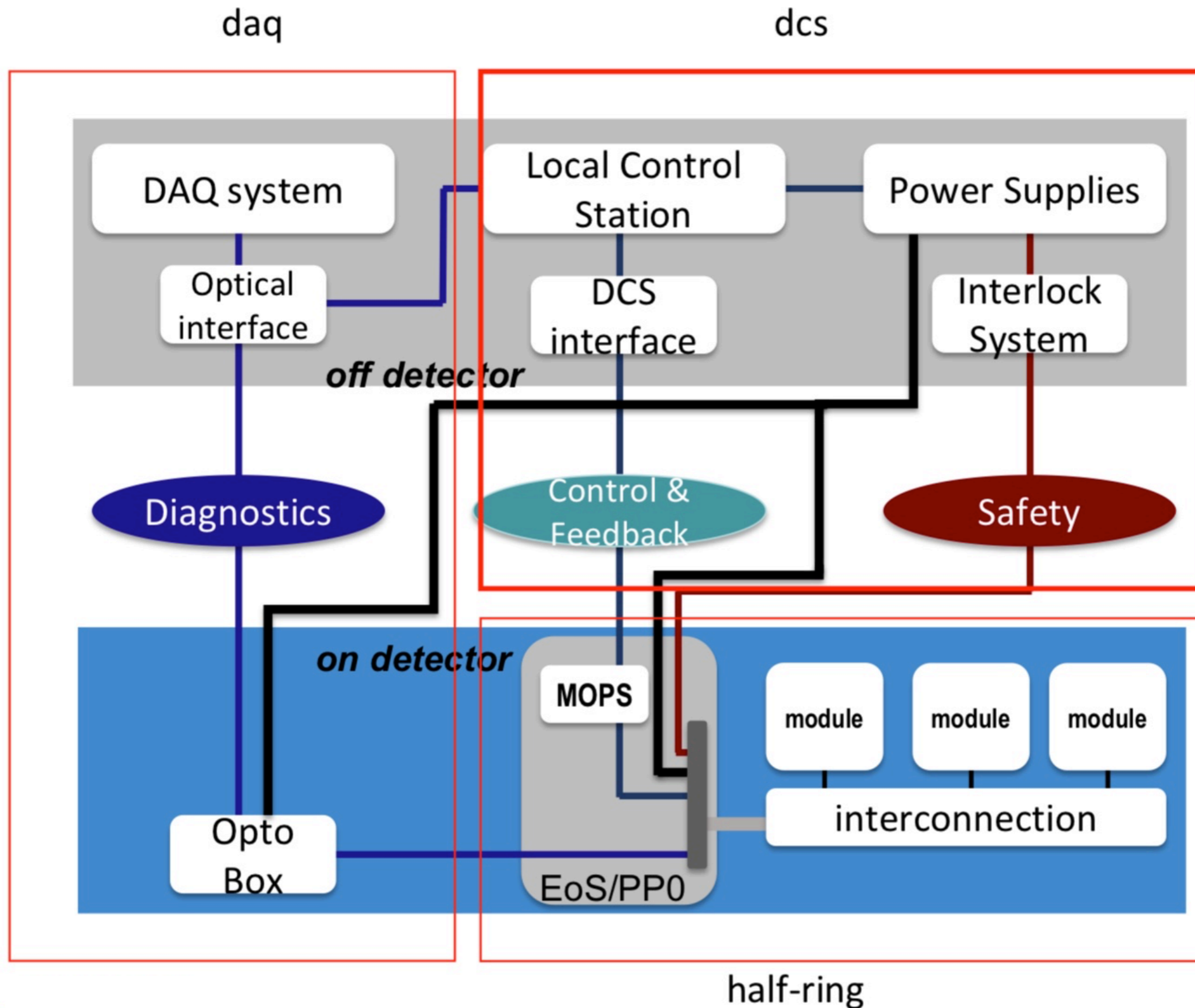
DCS: v5 bus tape and V4 EoS on Ring-1 have NTC and Vdrop monitoring i.e. MOPS compatible.

Note that final plan is to integrate EoS with bus tape. Kept separate now to make MOPS testing easier.

Data readout will be via the data pigtailed that come with the modules.

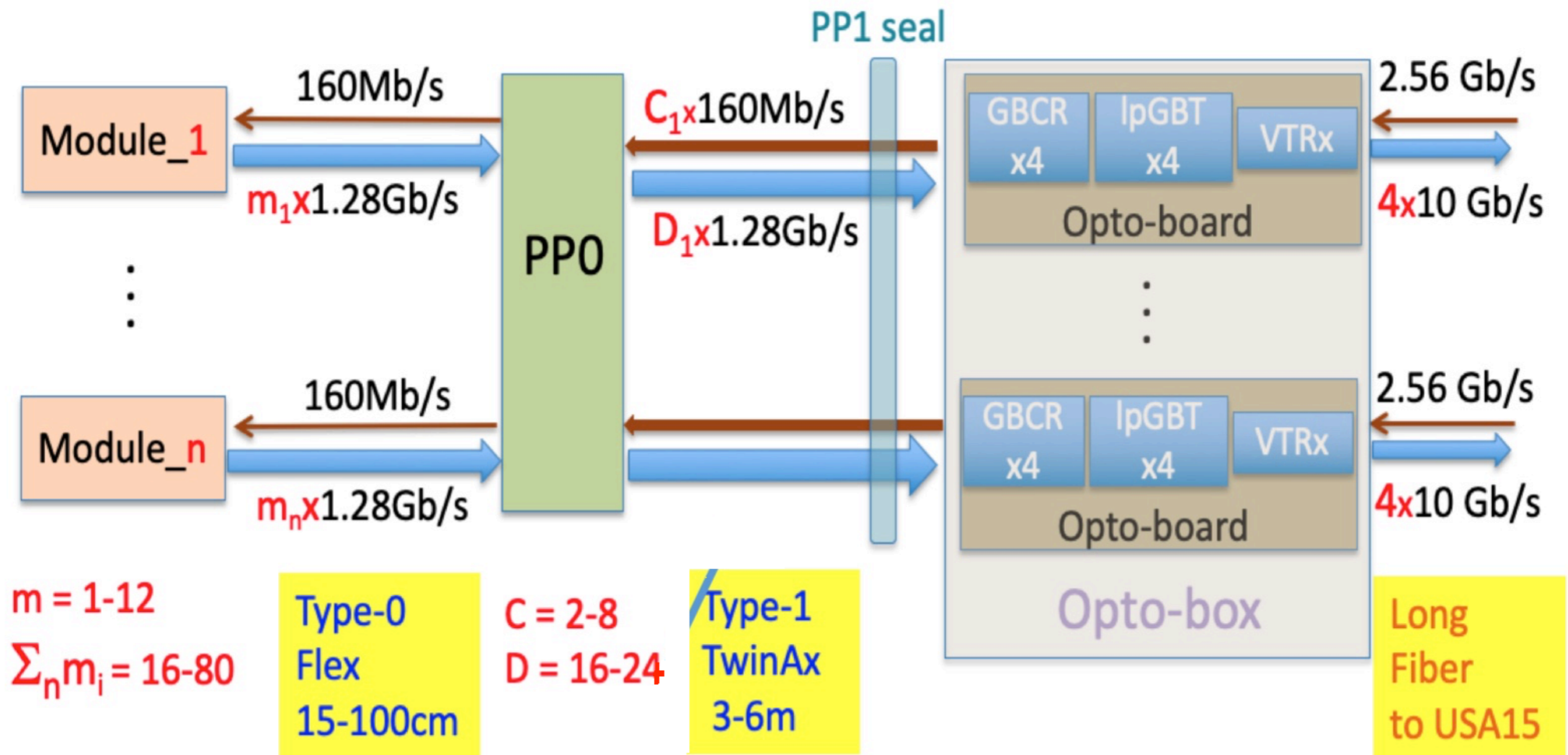
P. Sutcliffe, M. Langstaff, J. Pater

# System test



- + cooling
- + storage box
- + dry air

# Block Diagram of Data Transmission





# ITK Type 1 service

Sub-system	PPO end		Optoboard end		Total E-links
	Termination	#E-links	Termination	#E-links	
Inner System	Direct solder to PPO board	70-100	Samtec ERF8 connector	32 (24 data + 8 cmd)	9208
Outer Barrel	Samtec FireFly ECU5	4-12			9904
Outer Endcap	Direct solder to module flex	2-5			7072

Layer	Ring	Data+Cmd /module	Bundle 1 #module	Bundle 1 ERF8 Data+Cmd	Optoboard capacity bundle 1	Bundle 2 #module	Bundle 2 ERF8 Data+Cmd	bundle 2 Optoboard capacity
2	1-5	2+1	8	16+8	66%			
2	6-11	4+1	4	16+4	66%	4	16+4	66%
3	1-8	2+1	6	12+6	50%	5	10+5	42%
4	1-7	1+1	8	8+8	33%	5	5+5	21%
4	8-9	2+1	8	16+8	66%	5	10+5	42%

- 6 Flavors of Optoboard configuration.

# Common order twinax

Contact	Subsystem	Length (m)	Length (ft)	Length (ft)	cost (\$)
Su Dong	IS	7000			
Su Dong	IS	1500			
Su Dong	IS	2000	34449	35000	21000
Jeremy Love	IS	4000	13123	14000	8400
Susanne Kuehn	OB	3400	11155	12000	7200
Stephan Eisenhardt	EC	650			
Stephan Eisenhardt	EC	100			
Stephan Eisenhardt	EC	1950	8858	9000	5400
Sandro Tomassini	PP1	4500	14764	15000	9000
Petr Sicho	ID end region	0	0	0	
Sum		25100		85000	51000



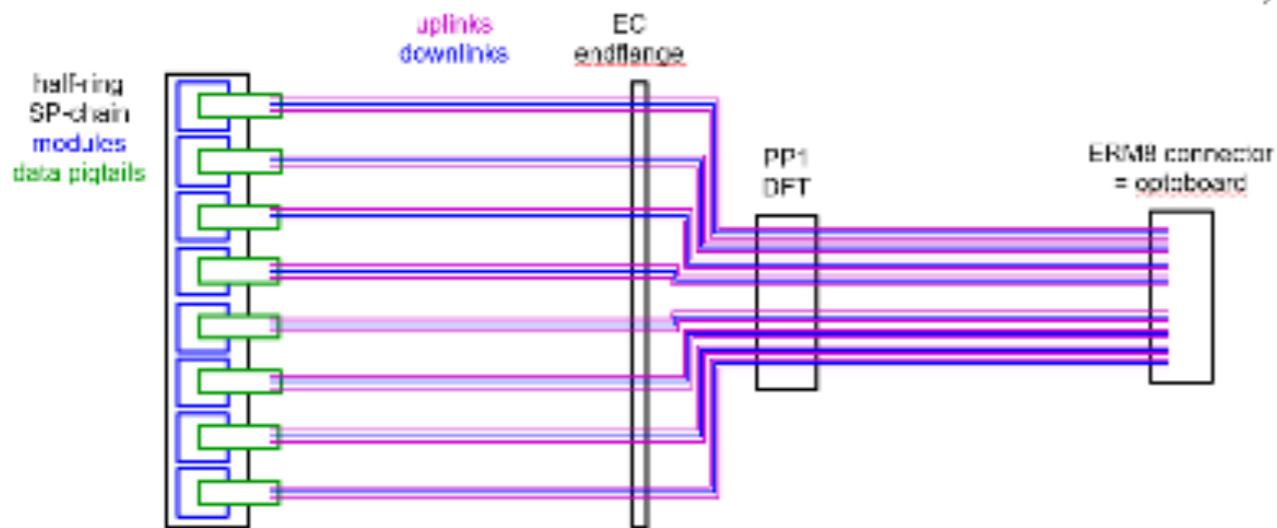
- Fabrication of ERF (Quantity 25) \$300ea
- Fabrication of Firefly (Quantity 25) \$100ea
- Cable weaving \$100 per bundle (2 bundles)
- Assembly cost (2 firefly PCBs-1 ERF board) \$500-\$600 per assembly
  - This is L2i configuration
  - Waiting on European Company quote
- Total ~\$1200 for a set.

# Inner half rings

## Cable Bundles – Layer 2, R01-R05

- Layer 2: R01-R05 – 8 modules/ bundle
- 3 Twinax / module: 24 Twinax / bundle

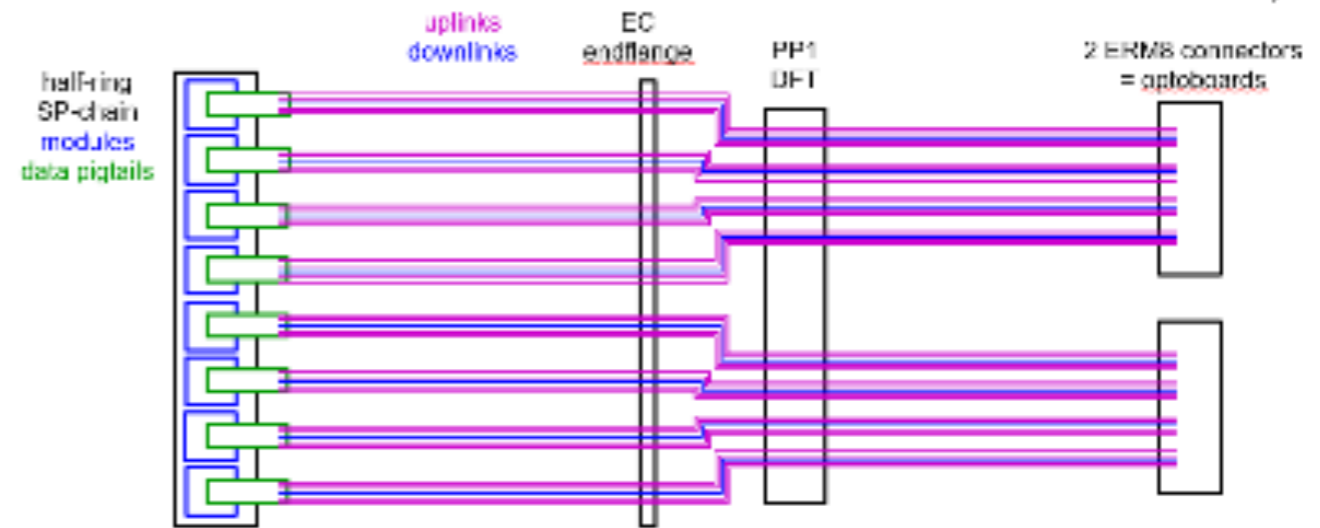
10 bundles / half-cylinder  
(5 half rings \* 2 SP-chains  
\* 1 bundle / SP-chain)



## Cable Bundles – Layer 2, R06-R11

- Layer 2: R06-R11 – 4 modules/ bundle
- 5 Twinax / module: 20 Twinax / bundle

24 bundles / half-cylinder  
(6 half rings \* 2 SP-chains  
\* 2 bundle / SP-chain)

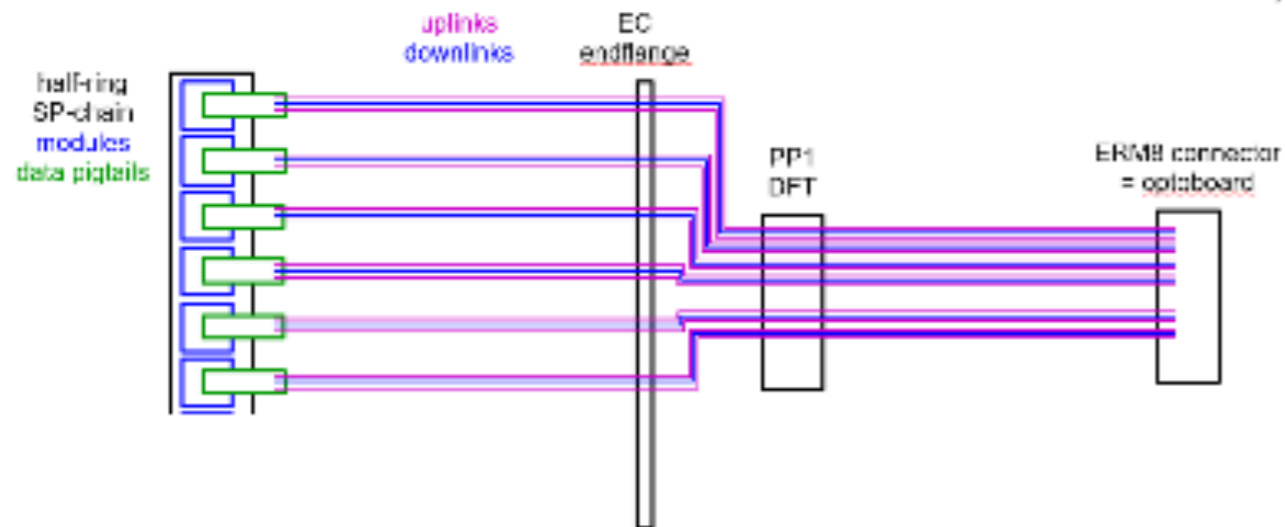


# Middle half rings

## Cable Bundles – Layer 3, R01-R08 a

- Layer 3: R01-R08 – 6 modules/ bundle
- 3 Twinax / module: 18 Twinax / bundle

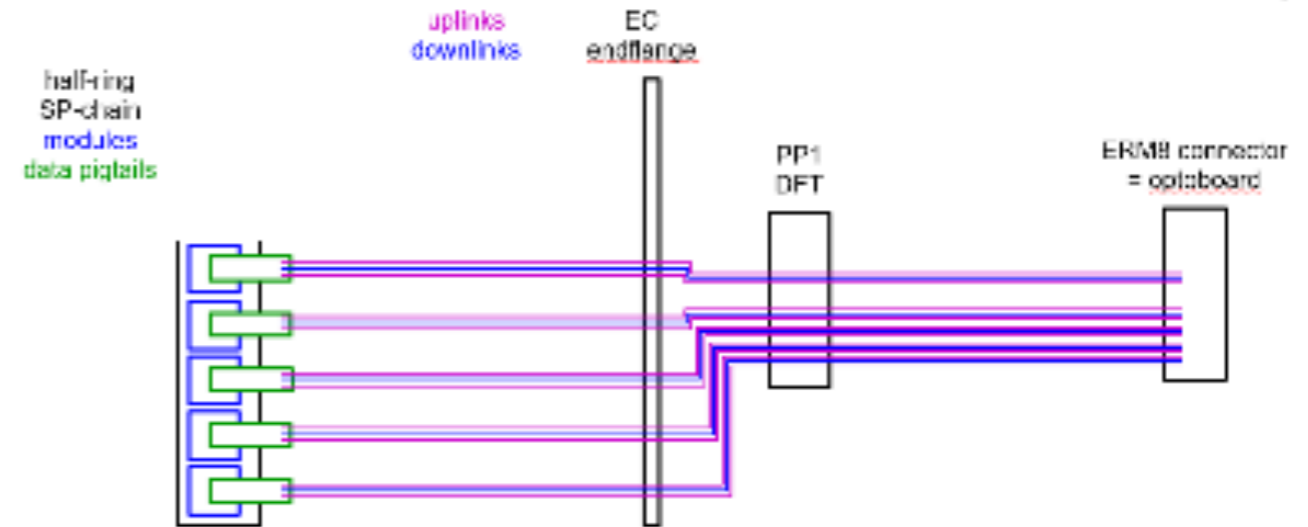
22 bundles / half cylinder  
(11 half-rings \* 2 SP-chains  
\* 1 bundle / SP-chain)



## Cable Bundles – Layer 3, R01-R08 b

- Layer 3: R01-R08 – 5 modules/ bundle
- 3 Twinax / module: 15 Twinax / bundle

22 bundles / half cylinder  
(11 half-rings \* 2 SP-chains  
\* 1 bundle / SP-chain)



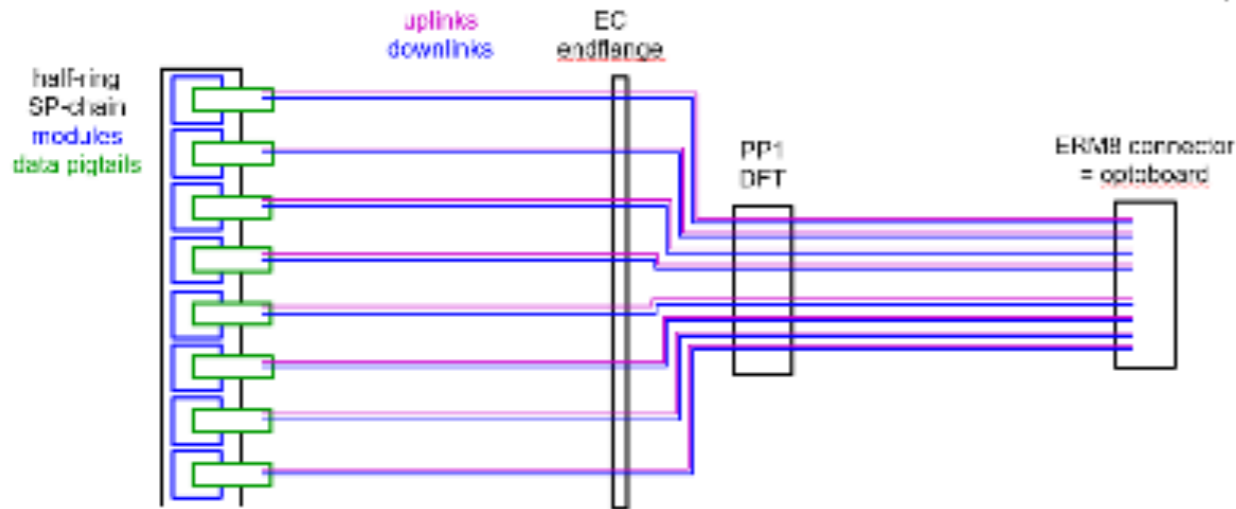


# Outer half ring

## Cable Bundles – Layer 4, R01-R07 a

- Layer 4: R01-R07 – 8 modules/ bundle
- 2 Twinax / module: 16 Twinax / bundle

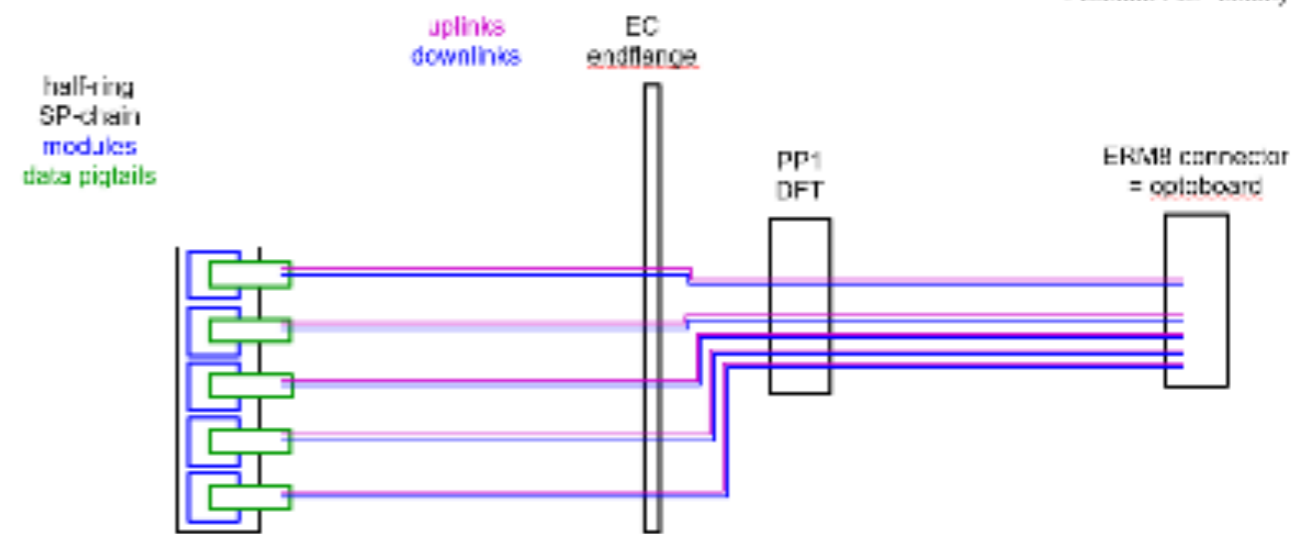
14 bundles / half cylinder  
(7 half rings \* 2 SP-chains  
\* 1 bundle / SP-chain)



## Cable Bundles – Layer 4, R01-R07 b

- Layer 4: R01-R07 – 5 modules/ bundle
- 2 Twinax / module: 10 Twinax / bundle

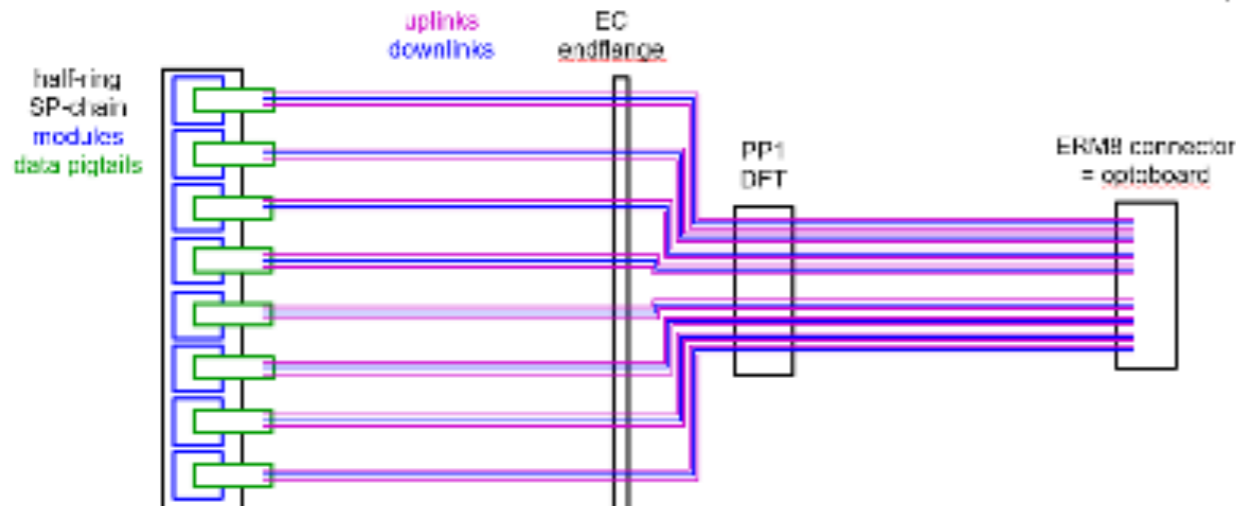
14 bundles / half cylinder  
(7 half rings \* 2 SP-chains  
\* 1 bundle / SP-chain)



## Cable Bundles – Layer 4, R08-R09 a

- Layer 4: R08-R09 – 8 modules/ bundle
- 3 Twinax / module: 24 Twinax / bundle

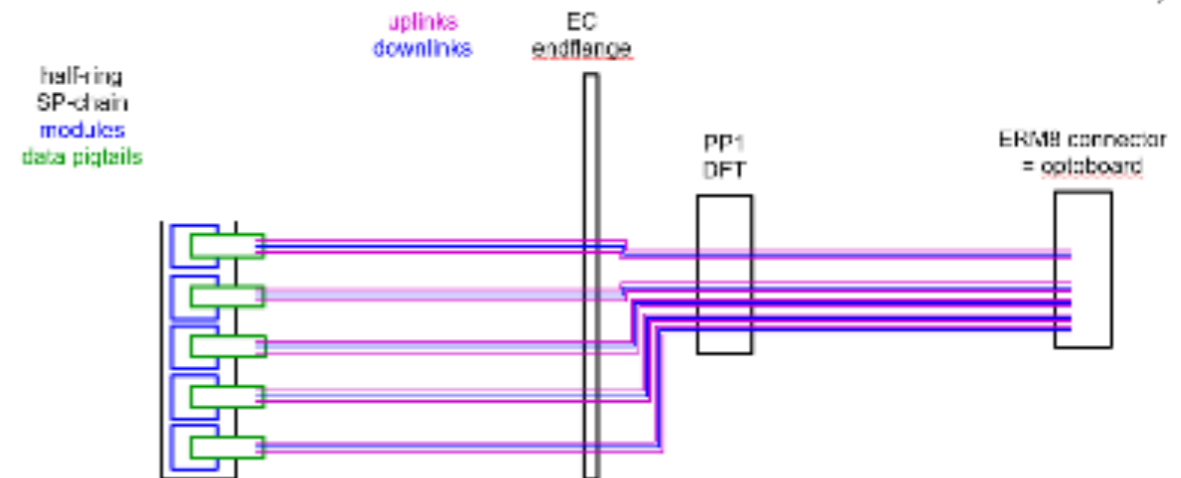
4 bundles / half cylinder  
(2 half rings \* 2 SP-chains  
\* 1 bundle / SP-chain)



## Cable Bundles – Layer 4, R08-R09 b

- Layer 4: R08-R09 – 5 modules/ bundle
- 3 Twinax / module: 15 Twinax / bundle

4 bundles / half cylinder  
(2 half rings \* 2 SP-chains  
\* 1 bundle / SP-chain)

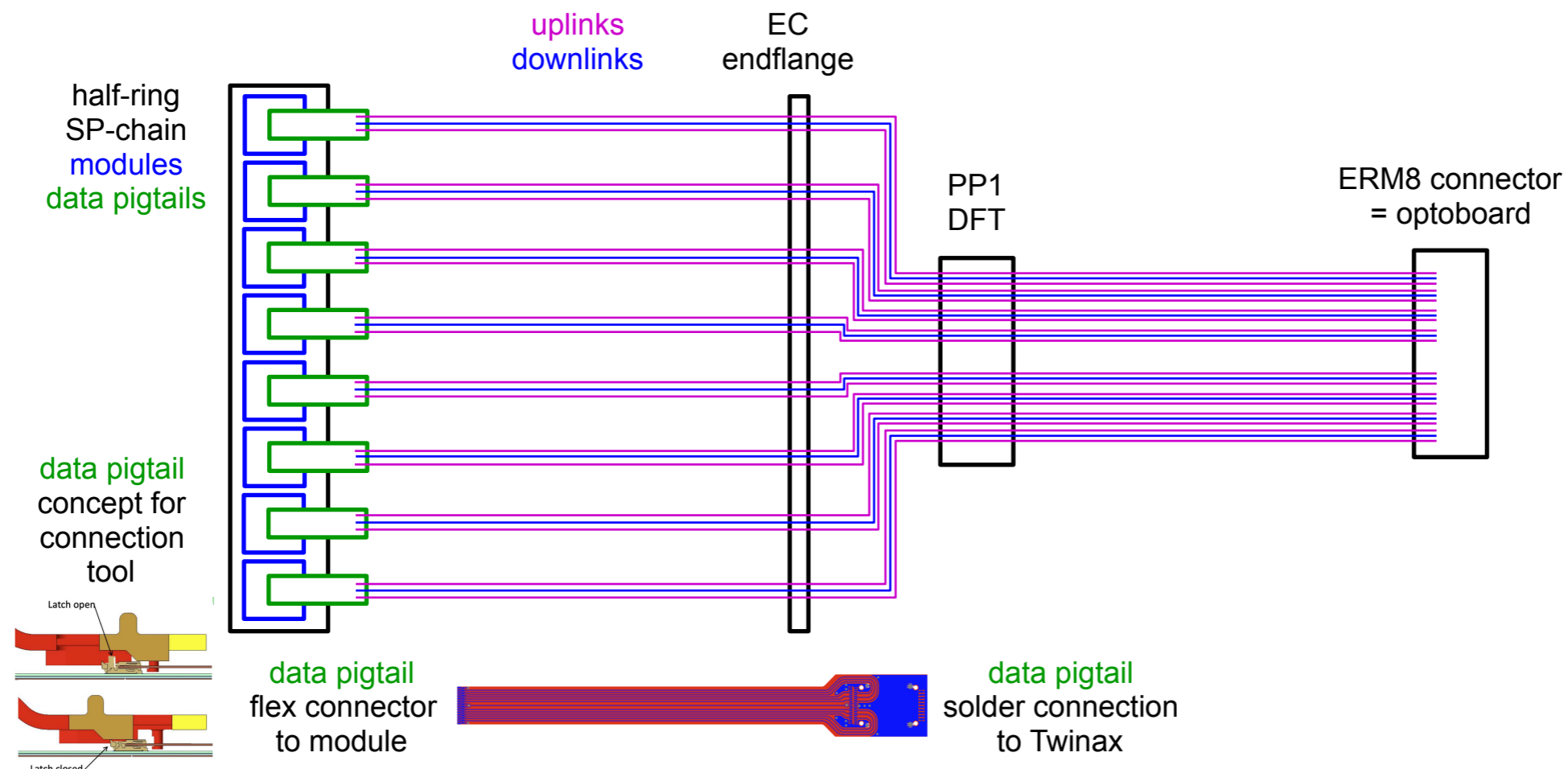


# Type 1 service: option 1

## Option 1: cable looming outside endcap

- Layer 2: R01-R05 – 8 modules/ bundle
  - 3 Twinax / module: 24 Twinax / bundle

10 bundles / half-cylinder  
(5 half-rings \* 2 SP-chains  
\* 1 bundle / SP-chain)



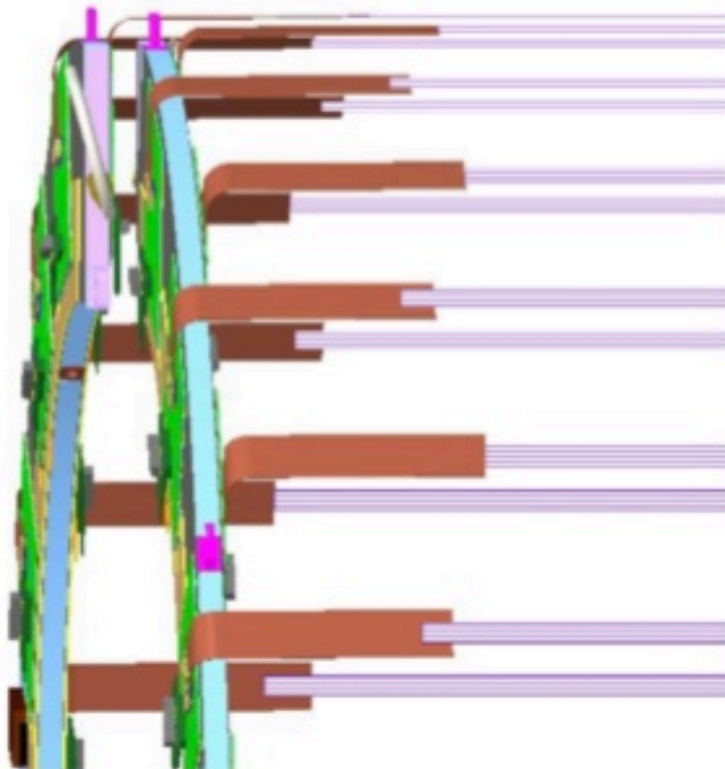
ITk week, Pixel Services, 24.09.2020

Stephan Eisenhardt

# Data pig tail

**Molex ZIF  
Mating  
connector**

**Samtec Firefly Connector  
oppure twinax saldato  
direttamente su pig tail**



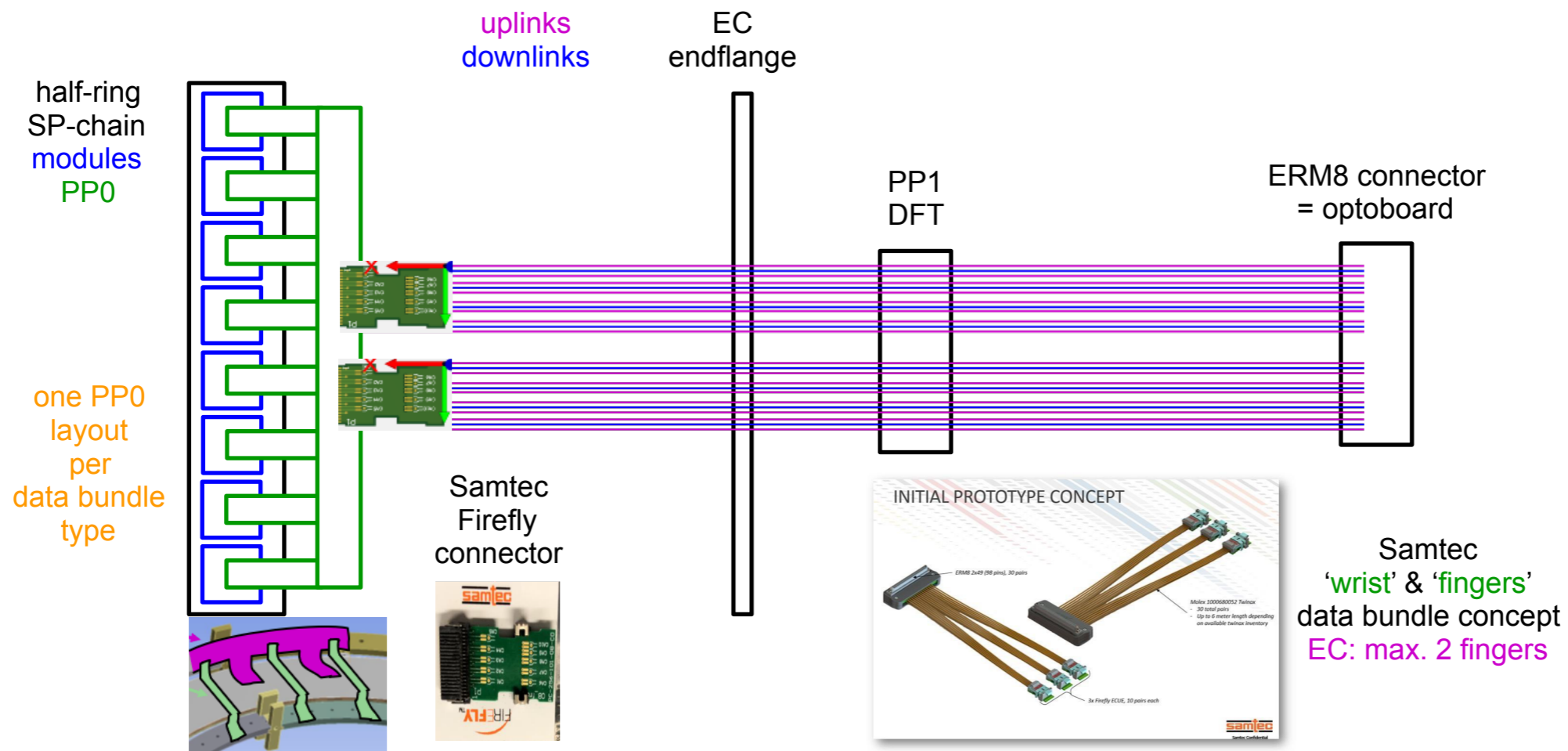
Current design [here](#)

# Type 1 service: option 3

## Option 3: PP0 flex(s) for looming

- Layer 2: R01-R05 – 8 modules/ bundle
  - 3 Twinax / module: 24 Twinax / bundle

10 bundles / half-cylinder  
 (5 half-rings \* 2 SP-chains  
 \* 1 bundle / SP-chain)



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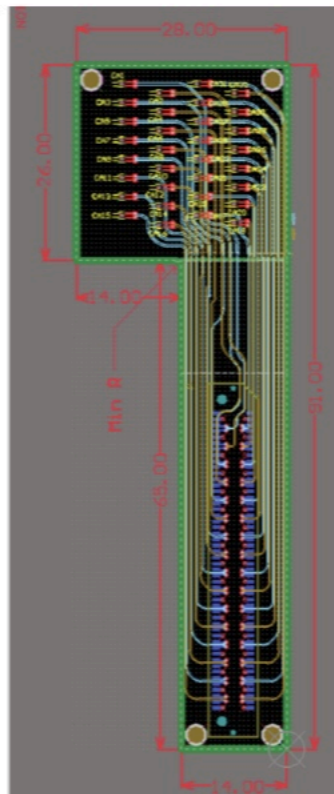
Samtec  
 'wrist' & 'fingers'  
 data bundle concept  
 EC: max. 2 fingers



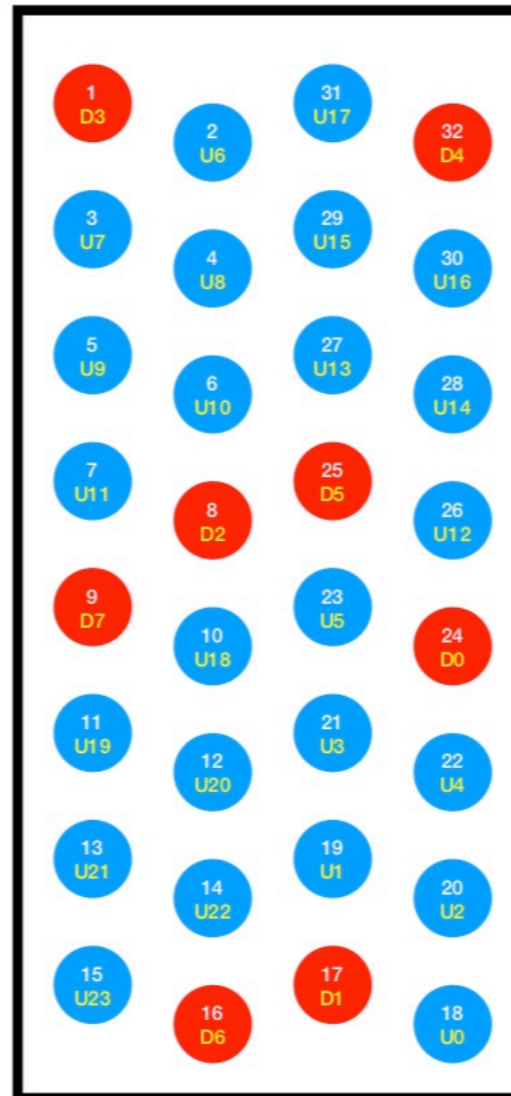
# Terminazione optoboard

## Termination board – Pinout

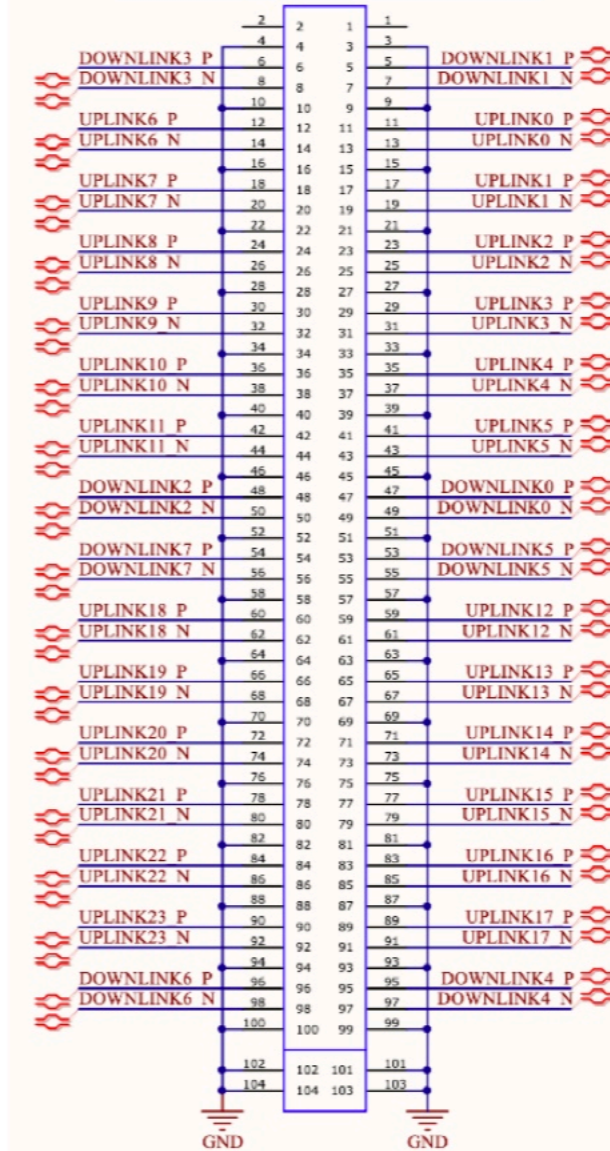
- \* Pinout of the ERF8 connector defined by the pinout of the mating connector on the Optoboard
- \* Correspondence between the soldering pads on the rigid PCB and the signal paths defined by routing on the board



Pinout Twinax cables at rigid PCB



Pinout ERF8 connector



ITk week - 24.09.2020 - Optosystem - L. Franconi

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